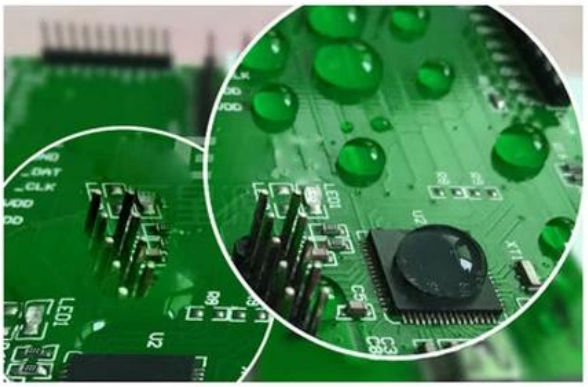
Description du produit

Meilleure marque originale,
Vérification de la qualité
Numéro d'article: Best-507 250g Solder Pâte
GAMME: Ordinateur portable / ordinateur / Appareils mobiles / ménagères SMD IC et BGA IC réparation, outil de niveau puceréparation Ligne de production électronique.

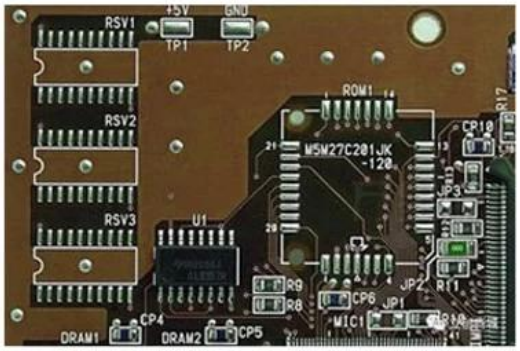
Product Usage

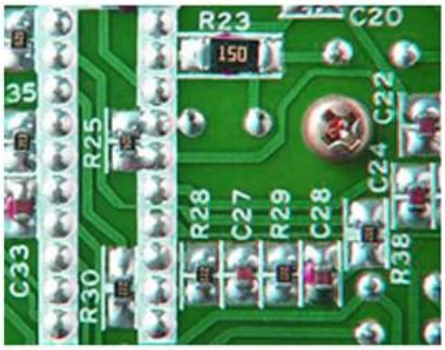
MODEL	BST-508
SHELF LIFE	6 months
INGREDIENT	Sn63/Pb37
WEIGHT	500g
MELTING POINT	183℃

Having a large insulation resistance does not corrode the PCB, and the requirements for no-cleaning can be achieved.



High impedance, full and bright solder, low residue



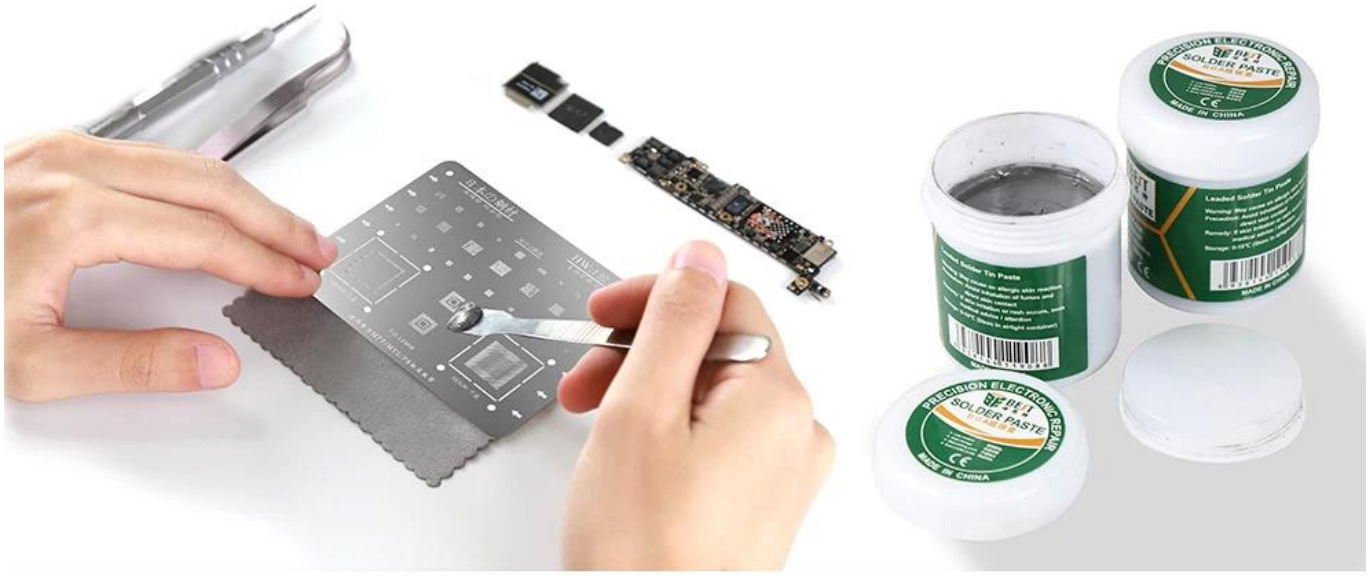


Welding requirements for a wide range of products

TESTING EFFECT

UNIFORM SOLDER JOINT

LOW TEMPERATURE MELTING POINT



PRODUCT SIZE